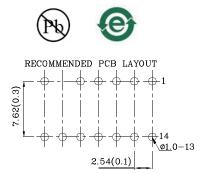


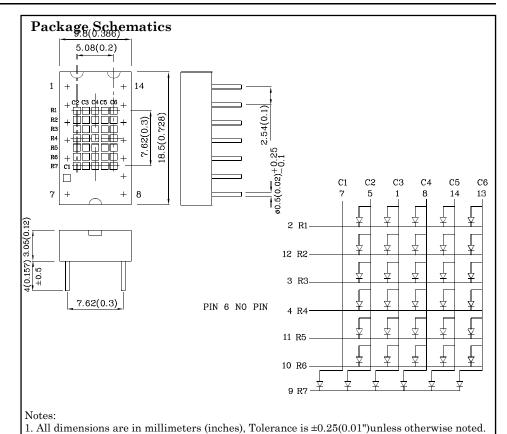


 $7.62\mathrm{mm}$  (0.3 ") SINGLE COLOR DOT MATRIX DISPLAY

### **Features**

- Low power consumption
- ullet Robust package
- I.C. Compatible
- Optional black face provides superior color contrast
- RoHS Compliant





Absolute Maximum Ratings $(T_A=25^{\circ}C)$		MR (GaAlAs)	Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	V
Forward Current	$I_{\mathrm{F}}$	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	155	mA
Power Dissipation	$P_{D}$	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	C
Lead Solder Temperature [2mm Below Package Base]	260°C For 3-5 Seconds		

Operating Characteristics (T <sub>A</sub> =25°C)		MR (GaAlAs)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	1.8	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λΡ	655*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	640*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)		45	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (I <sub>F</sub> =10mA) ucd		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XMMR07A	Red	GaAlAs	14000 3600*	29990 7490*	655*	Column Anode

2. Specifications are subject to change without notice.

Mar 03,2014

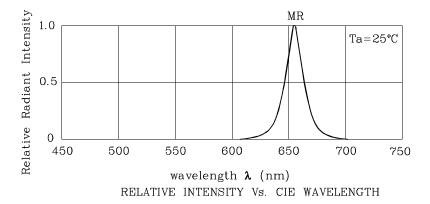
XDSA1807 V8-X Layout: Maggie L.

<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

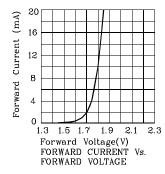
# Part Number: XMMR07A

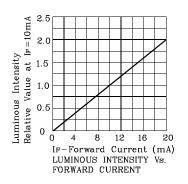
7.62mm (0.3 ") SINGLE COLOR DOT MATRIX DIS-**PLAY** 

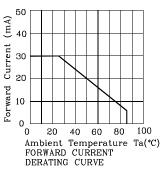


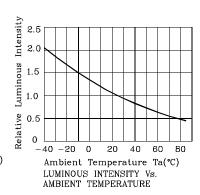


# ❖ MR

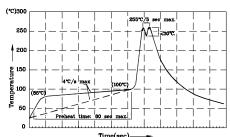








Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- nmend pre-heat temperature of 105°C or less (as measured with a noccouple attached to the LED pins) prior to immersion in the solder with a maximum solder bath temperature of 250°C wave soldering temperature between 245°C  $\sim$  255°C for 3 sec (5 sec
- 2.Peak wave soldering temperature betweenax).
  3.Do not apply stress to the epoxy resin (-Pixtures should not incur stress on the during soldering process.
  5.SAC 305 solder alloy is recommended.
  6.No more than one wave soldering pass.

### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

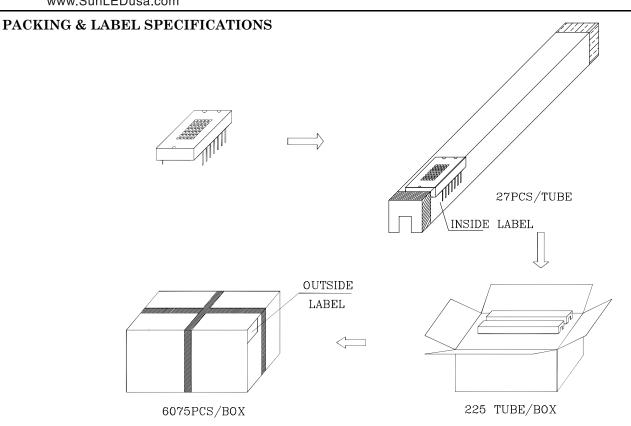
Note: Accuracy may depend on the sorting parameters.



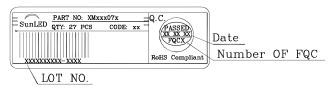
# Part Number: XMMR07A

 $7.62\mathrm{mm}$  (0.3 ") SINGLE COLOR DOT MATRIX DISPLAY

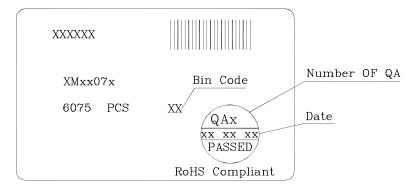




# Inside Label On IC-TUBE



# Outside Label On Box



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